

60V Battery Gas Gauge with Temperature, Voltage and Current Measurement

FEATURES

- Measures Accumulated Battery Charge and Discharge
- 3.6V to 60V Operating Range for Multiple Cells
- 14-Bit ADC Measures Voltage, Current and Temperature
- 1% Voltage, Current and Charge Accuracy
- $\pm 50\text{mV}$ Sense Voltage Range
- High Side Sense
- I²C Interface/SMBus Interface
- General Purpose Measurements for Any Battery Chemistry and Capacity
- Configurable Alert Output/Charge Complete Input
- Quiescent Current Less Than 150 μA
- Small 8-Lead 3mm $\times$ 3mm DFN Package

APPLICATIONS

- Electric and Hybrid Electric Vehicles
- Power Tools
- Electric Bicycles, Motorcycles, Scooters
- High Power Portable Equipment
- Photo Voltaics
- Backup Battery Systems

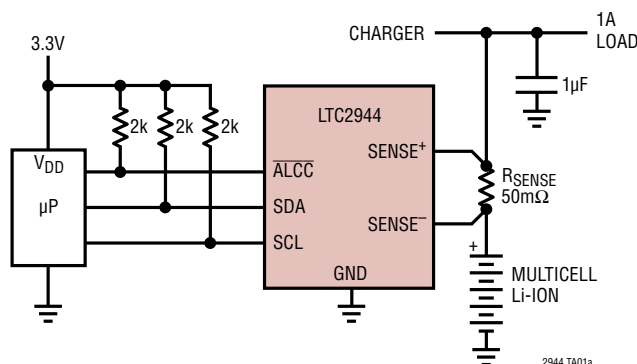
DESCRIPTION

The LTC[®]2944 measures battery charge state, battery voltage, battery current and its own temperature in portable product applications. The wide input voltage range allows use with multicell batteries up to 60V. A precision coulomb counter integrates current through a sense resistor between the battery's positive terminal and the load or charger. Voltage, current and temperature are measured with an internal 14-bit No Latency $\Delta\Sigma^{\text{TM}}$ ADC. The measurements are stored in internal registers accessible via the onboard I²C/SMBus Interface.

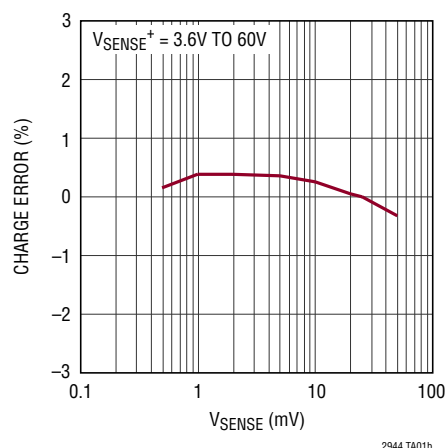
The LTC2944 features programmable high and low thresholds for all four measured quantities. If a programmed threshold is exceeded, the device communicates an alert using either the SMBus alert protocol or by setting a flag in the internal status register. The LTC2944 requires only a single low value sense resistor to set the measured current range.

All registered trademarks and trademarks are the property of their respective owners.

TYPICAL APPLICATION



Total Charge Error vs
Differential Sense Voltage



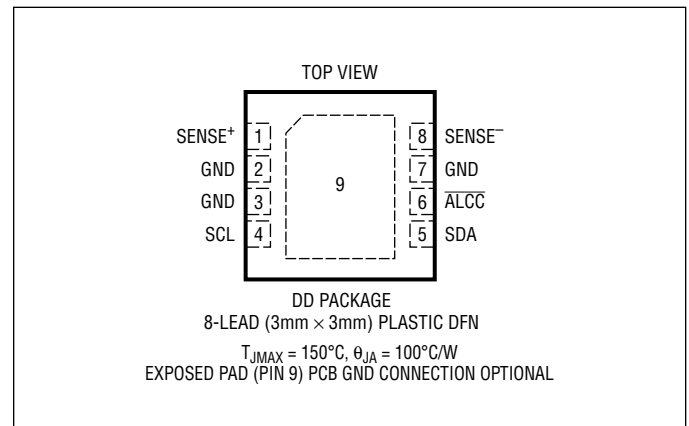
LTC2944

ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Supply Voltage (SENSE ⁺)	–0.3V to 65V
SCL, SDA, ALCC Voltage	–0.3V to 6V
SENSE [–]	(–0.3V + V _{SENSE⁺}) to (V _{SENSE⁺} + 0.3V)
Operating Ambient Temperature Range	
LTC2944C	0°C to 70°C
LTC2944I	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION <http://www.linear.com/product/LTC2944#orderinfo>

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC2944CDD#PBF	LTC2944CDD#TRPBF	LGCR	8-Lead (3mm × 3mm) Plastic DFN	0°C to 70°C
LTC2944IDD#PBF	LTC2944IDD#TRPBF	LGCR	8-Lead (3mm × 3mm) Plastic DFN	–40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandree/>. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}\text{C}$. (Note 2)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Requirements							
V _{SENSE+}	Supply Voltage		●	3.6		60	V
I _{SUPPLY}	Supply Current (Note 3)	Battery Gas Gauge On, ADC Sleep Battery Gas Gauge On, ADC On Shutdown	● ● ●		80 850 15	150 950 30	μA μA μA
I _{SENSE+}	Pin Current (Note 3)	Battery Gas Gauge On, ADC Sleep Battery Gas Gauge On, ADC On Shutdown			80 500 15		μA μA μA
I _{SENSE−}	Pin Current (Note 3)	Battery Gas Gauge On, ADC Sleep Battery Gas Gauge On, ADC On Shutdown			1 350 1		μA μA μA
V _{UVLO}	Undervoltage Lockout Threshold	V _{SENSE+} Falling	●	3.0	3.5	3.6	V
Coulomb Counter							
V _{SENSE}	Sense Voltage Differential Input Range	V _{SENSE+} − V _{SENSE−}	●			±50	mV
R _{IDR}	Differential Input Resistance Across SENSE+ and SENSE− (Note 8)				400		kΩ
q _{LSB}	Charge LSB (Note 4)	Prescaler M = 4096(Default), R _{SENSE} = 50mΩ			0.340		mAh

2944fa

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
TCE	Total Charge Error (Note 5)	$10\text{mV} \leq V_{\text{SENSE}} \leq 50\text{mV DC}$ $10\text{mV} \leq V_{\text{SENSE}} \leq 50\text{mV DC}$ $1\text{mV} \leq V_{\text{SENSE}} \leq 10\text{mV DC (Note 8)}$	●		± 1 ± 1.5 ± 3.5	% % %
V_{OSE}	Effective Differential Offset Voltage (Note 9)	$V_{\text{SENSE}} \geq 500\mu\text{V}$, $V_{\text{SENSE}+} = 30\text{V}$	●	5	10	μV

Voltage Measurement ADC

	Resolution (No Missing Codes)	(Note 8)	●	14		Bits
$V_{\text{FS(V)}}$	Full-Scale Voltage Conversion			70.8		V
ΔV_{LSB}	Quantization Step of 14-Bit Voltage ADC	(Note 6)		4.32		mV
TUE_V	Voltage Total Unadjusted Error		●		1 1.3	% %
Gain_V	Voltage Gain Accuracy		●		1.3	%
INL_V	Integral Nonlinearity		●	± 1	± 4	LSB
$T_{\text{CONV(V)}}$	Voltage Conversion Time		●		48	ms

Current Measurement ADC

	Resolution (No Missing Codes)	(Note 8)	●	12		Bits
$V_{\text{FS(I)}}$	Full-Scale Current Conversion			± 64		mV
V_{SENSE}	Sense Voltage Differential Input Range	$V_{\text{SENSE}+} - V_{\text{SENSE}-}$	●		± 50	mV
ΔI_{LSB}	Quantization Step of 12-Bit Current ADC	(Note 6)		31.25		μV
Gain_I	Current Gain Accuracy		●		1 1.3	% %
$V_{\text{OS(I)}}$	Offset			± 1	± 10	LSB
INL_I	Integral Nonlinearity		●	± 1	± 4	LSB
$T_{\text{CONV(I)}}$	Current Conversion Time		●		8	ms

Temperature Measurement ADC

	Resolution (No Missing Codes)	(Note 8)	●	11		Bits
T_{FS}	Full-Scale Temperature			510		K
ΔT_{LSB}	Quantization Step of 11-Bit Temperature ADC	(Note 6)		0.25		K
TUE_T	Temperature Total Unadjusted Error	$V_{\text{SENSE}+} \geq 5\text{V}$ (Note 8)	●		± 3 ± 5	K K
$T_{\text{CONV(T)}}$	Temperature Conversion Time		●		8	ms

Digital Inputs and Digital Outputs

$V_{\text{ITH(HV)}}$	Logic Input Threshold	$V_{\text{SENSE}+} \geq 5\text{V}$	●	0.8	2.2	V
$V_{\text{ITH(LV)}}$		$3.6\text{V} < V_{\text{SENSE}+} < 5\text{V}$		0.5	1.8	V
V_{OL}	Low Level Output Voltage, $\overline{\text{ALCC}}$, SDA	$I = 3\text{mA}$, $V_{\text{SENSE}+} \geq 5\text{V}$	●		0.4	V
I_{IN}	Input Leakage, $\overline{\text{ALCC}}$, SCL, SDA	$V_{\text{IN}} = 5\text{V}$	●		1	μA
C_{IN}	Input Capacitance, $\overline{\text{ALCC}}$, SCL, SDA	(Note 8)	●		10	pF
t_{PCC}	Minimum Charge Complete ($\overline{\text{CC}}$) Pulse Width				1	μs

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
I²C Timing Characteristics						
$f_{\text{SCL(MAX)}}$	Maximum SCL Clock Frequency		●	400	900	kHz
$t_{\text{BUF(MAX)}}$	Bus Free Time Between Stop/Start		●		1.3	μs
$t_{\text{SU(STA(MIN))}}$	Minimum Repeated Start Set-Up Time		●		600	ns
$t_{\text{HD(STA(MIN))}}$	Minimum Hold Time (Repeated) Start Condition		●		600	ns
$t_{\text{SU(STO(MIN))}}$	Minimum Set-Up Time for Stop Condition		●		600	ns
$t_{\text{SU(DAT(MIN))}}$	Minimum Data Setup Time Input		●		100	ns
$t_{\text{HD(DAT(MIN))}}$	Minimum Data Hold Time Input		●		50	ns
T_{HDDATO}	Data Hold Time Input Output		●	0.3	0.9	μs
T_{OF}	Data Output Fall Time	(Notes 7, 8)	●	$20 + 0.1 \cdot C_B$	300	ns

Note 1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2. All currents into pins are positive, all voltages are referenced to GND unless otherwise specified.

Note 3. $I_{\text{SUPPLY}} = I_{\text{SENSE}^+} + I_{\text{SENSE}^-}$. In most operating modes I_{SUPPLY} is flowing in SENSE^+ pin. Only during ADC conversions current is flowing in SENSE^- pin as well. Typically, $I_{\text{SENSE}^-} = V_{\text{SENSE}^-}/150\text{k}$ during ADC voltage conversion and $I_{\text{SENSE}^-} = 20\mu\text{A}$ during ADC current conversion.

Note 4. The equivalent charge of an LSB in the accumulated charge register depends on the value of R_{SENSE} and the setting of the internal prescaling factor M:

$$q_{\text{LSB}} = 0.340\text{mAh} \cdot (50\text{m}\Omega/R_{\text{SENSE}}) \cdot (M/4096):$$

See Choosing R_{SENSE} and Choosing Coulomb Counter Prescaler M section for more information. $1\text{mAh} = 3.6\text{C}$ (Coulombs)

Note 5. Deviation of q_{LSB} from its nominal value.

Note 6. The quantization step of the 14-bit ADC in voltage mode, 12-bit ADC in current mode and 11-bit ADC in temperature mode is not the same as the LSB of the respective combined 16-bit registers. See the Voltage, Current and Temperature Registers section for more information.

Note 7. C_B = Capacitance of one bus line in pF ($10\text{pF} \leq C_B \leq 400\text{pF}$).

Note 8. Guaranteed by design, not subject to test.

Note 9. See "Effect of Differential Offset Voltage on Total Charge Error" section.

TIMING DIAGRAM

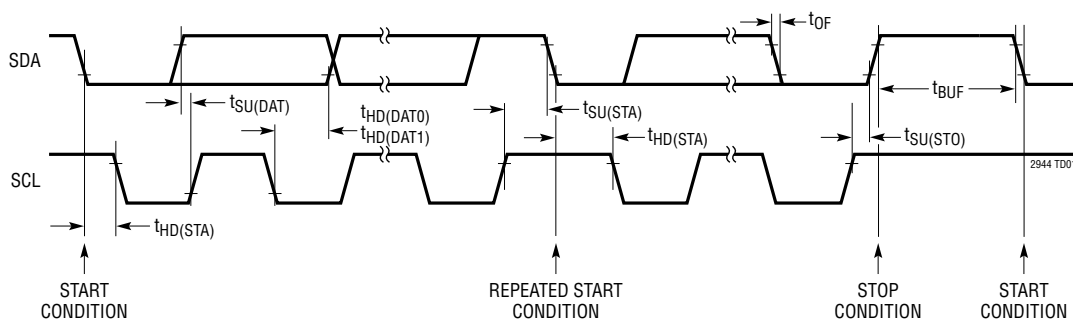
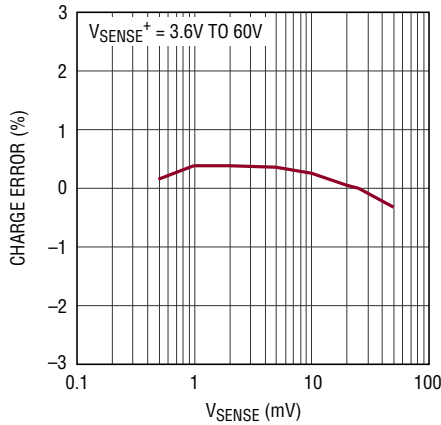


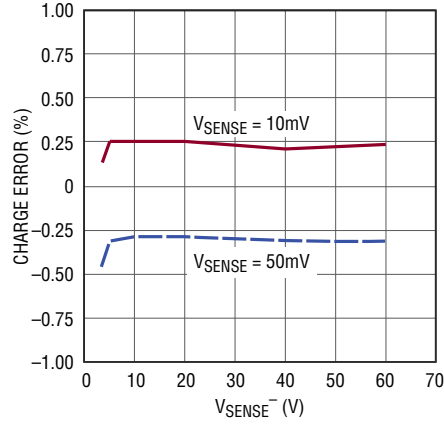
Figure 1. Definition of Timing on I²C Bus

TYPICAL PERFORMANCE CHARACTERISTICS

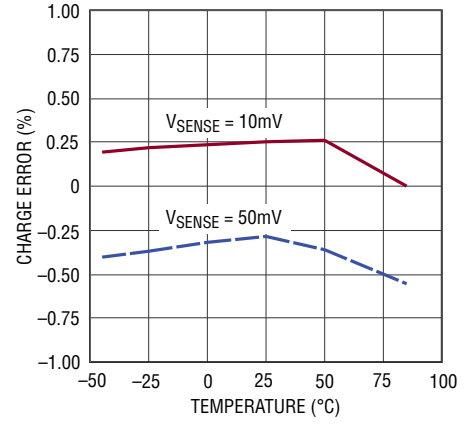
Total Charge Error vs Differential Sense Voltage



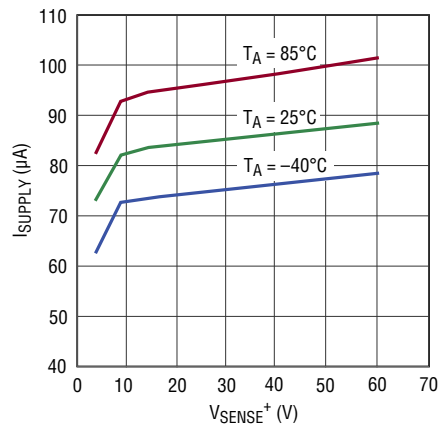
Total Charge Error vs Supply Voltage



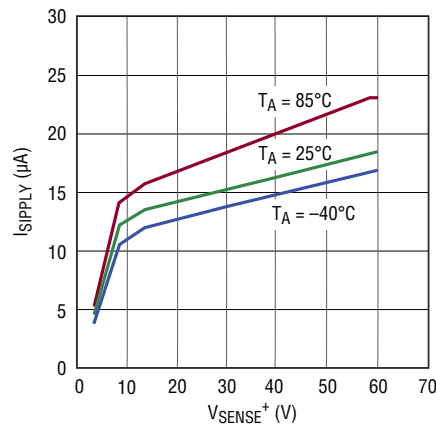
Total Charge Error vs Temperature



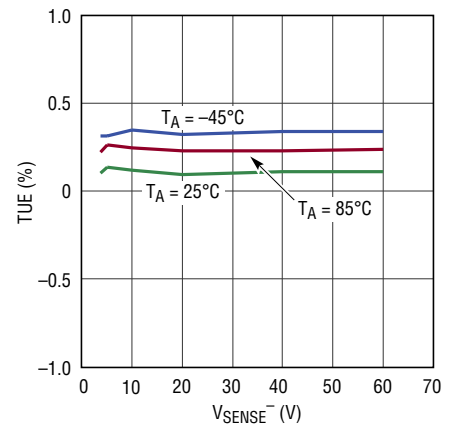
Supply Current vs Supply Voltage



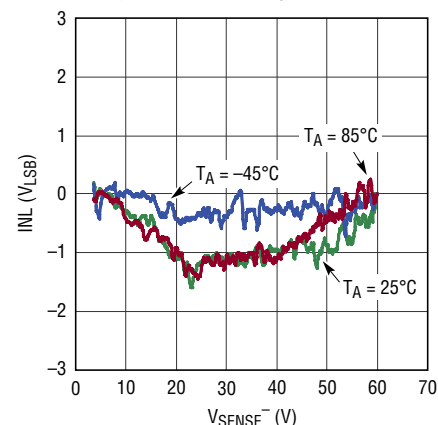
Shutdown Supply Current vs Supply Voltage



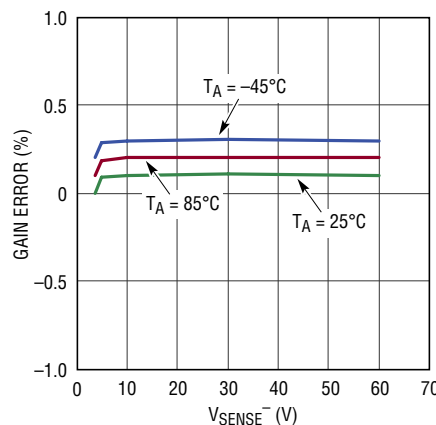
Voltage Measurement ADC Total Unadjusted Error



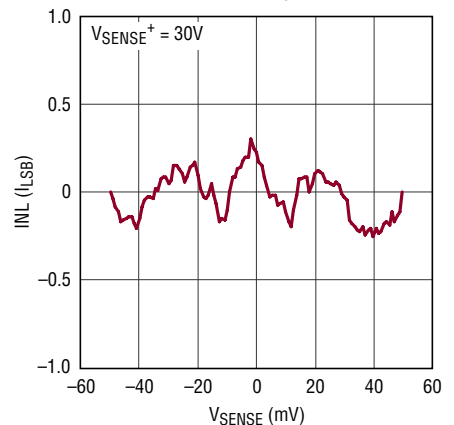
Voltage Measurement ADC Integral Nonlinearity



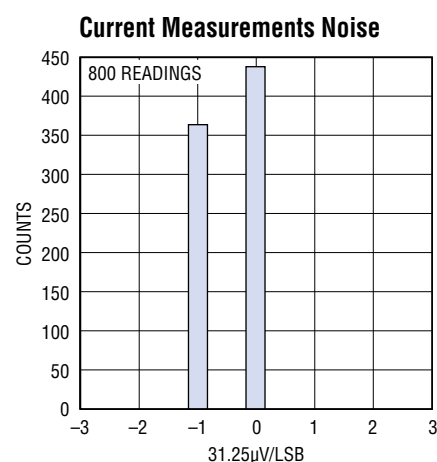
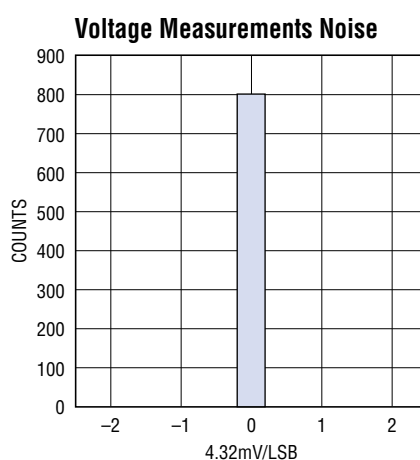
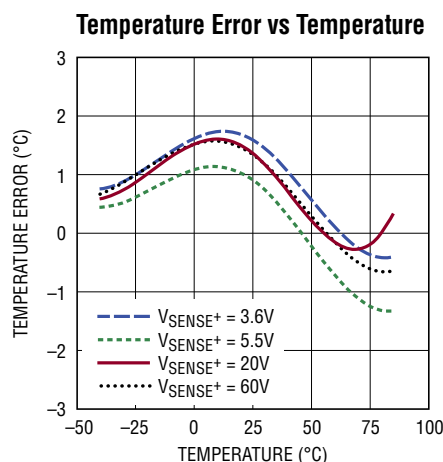
Current Measurement ADC Gain Error



Current Measurement ADC Integral Nonlinearity



TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS

SENSE⁺ (Pin 1): Positive Current Sense Input and Power Supply. Connect to load/charger side of the sense resistor. V_{SENSE+} operating range is 3.6V to 60V. SENSE⁺ is also an input to the ADC during current measurement. Bypass to GND with a 1 μF capacitor located as close to pin 1 and pin 2 as possible.

GND (Pin 2, Pin 3, Pin 7): Device Ground. Connect directly to the negative battery terminal.

SCL (Pin 4): Serial Bus Clock Input. SCL is internally pulled up with 50 μA (typ) above its logic input high threshold to about 2V (typ).

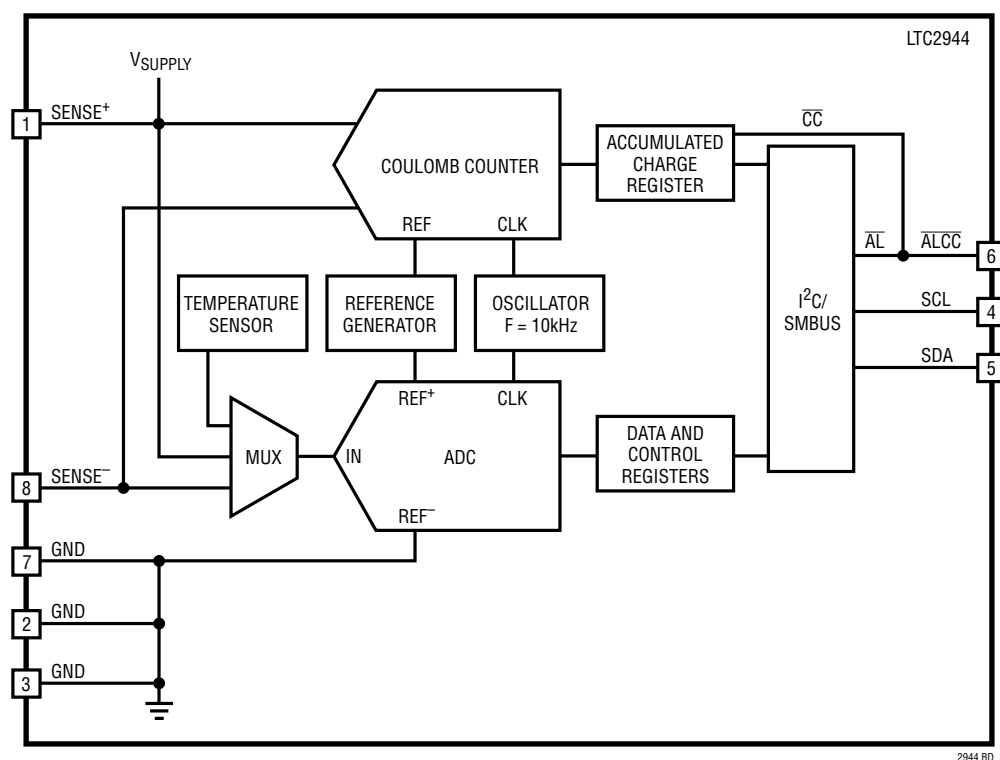
SDA (Pin 5): Serial Bus Data Input and Output. SDA is internally pulled up with 50 μA (typ) above its logic input high threshold to about 2V (typ).

ALCC (Pin 6): Alert Output or Charge Complete Input. Configured either as an SMBus alert output or charge complete input by control register bits B[2:1]. At power-up, the pin defaults to alert mode conforming to the SMBus alert response protocol. It behaves as an open-drain logic output that pulls to GND when any threshold register value is exceeded. When configured as a charge complete input, connect to the charge complete output from the battery charger circuit. A low level at $\overline{CC}$ sets the value of the accumulated charge (registers C, D) to FFFFh.

SENSE⁻ (Pin 8): Negative Current Sense Input. Connect SENSE⁻ to the positive battery terminal side of the sense resistor. The voltage between SENSE⁻ and SENSE⁺ must remain within $\pm 50mV$ in normal operation. SENSE⁻ is also an input to the ADC during voltage and current measurement.

Exposed Pad (Pin 9): Exposed pad may be left open or connected to device ground (GND).

BLOCK DIAGRAM



APPLICATIONS INFORMATION

Internal Registers

The LTC2944 register map is shown in Table 1. The LTC2944 integrates current through a sense resistor, measures battery voltage, current and temperature and stores the results in internal 16-bit registers accessible via I²C. High and low limits can be programmed for each measured quantity. The LTC2944 continuously monitors these limits and sets a flag in the status register when a limit is exceeded. If the alert mode is enabled, the $\overline{\text{ALCC}}$ pin pulls low.

Table 1. Register Map

ADDRESS	NAME	REGISTER DESCRIPTION	R/W	DEFAULT
00h	A	Status	R	See Table 2
01h	B	Control	R/W	3Ch
02h	C	Accumulated Charge MSB	R/W	7Fh
03h	D	Accumulated Charge LSB	R/W	FFh
04h	E	Charge Threshold High MSB	R/W	FFh
05h	F	Charge Threshold High LSB	R/W	FFh
06h	G	Charge Threshold Low MSB	R/W	00h
07h	H	Charge Threshold Low LSB	R/W	00h
08h	I	Voltage MSB	R	00h
09h	J	Voltage LSB	R	00h
0Ah	K	Voltage Threshold High MSB	R/W	FFh
0Bh	L	Voltage Threshold High LSB	R/W	FFh
0Ch	M	Voltage Threshold Low MSB	R/W	00h
0Dh	N	Voltage Threshold Low LSB	R/W	00h
0Eh	O	Current MSB	R	00h
0Fh	P	Current LSB	R	00h
10h	Q	Current Threshold High MSB	R/W	FFh
11h	R	Current Threshold High LSB	R/W	FFh
12h	S	Current Threshold Low MSB	R/W	00h
13h	T	Current Threshold Low LSB	R/W	00h
14h	U	Temperature MSB	R	00h
15h	V	Temperature LSB	R	00h
16h	W	Temperature Threshold High	R/W	FFh
17h	X	Temperature Threshold Low	R/W	00h

R = Read, W = Write

The status of the charge, voltage, current and temperature alerts is reported in the status register shown in Table 2.

Table 2. Status Register (A)

BIT	NAME	OPERATION	DEFAULT
A[7]	Reserved		
A[6]	Current Alert	Indicates one of the current limits was exceeded	0
A[5]	Accumulated Charge Overflow/Underflow	Indicates that the value of the ACR hit either top or bottom	0
A[4]	Temperature Alert	Indicates one of the temperature limits was exceeded	0
A[3]	Charge Alert High	Indicates that the ACR value exceeded the charge threshold high limit	0
A[2]	Charge Alert Low	Indicates that the ACR value exceeded the charge threshold low limit	0
A[1]	Voltage Alert	Indicates one of the voltage limits was exceeded	0
A[0]	Undervoltage Lockout Alert	Indicates recovery from undervoltage. If set to 1, a UVLO has occurred and the contents of the registers are uncertain	1

After each voltage, current or temperature conversion, the conversion result is compared to the respective threshold registers. If a value in the threshold registers is exceeded, the corresponding bit A[6], A[4] or A[1] is set.

The accumulated charge register (ACR) is compared to the charge thresholds every time the analog integrator increments or decrements the prescaler. If the ACR value exceeds the threshold register values, the corresponding bit A[3] or A[2] are set. Bit A[5] is set if the accumulated charge registers (ACR) overflows or underflows. At each overflow or underflow, the ACR rolls over and resumes integration.

The undervoltage lockout (UVLO) bit of the status register A[0] is set if, during operation, the voltage on the SENSE⁺ pin drops below 3.5V without reaching the POR level. The analog parts of the coulomb counter are switched off while the digital register values are retained. After recovery of the supply voltage, the coulomb counter resumes integrating

APPLICATIONS INFORMATION

with the stored value in the accumulated charge registers but it has missed any charge flowing while $\text{SENSE}^+ < 3.5\text{V}$.

All status register bits are cleared after being read by the host, but might be reasserted after the next temperature, voltage or current conversion or charge integration, if the corresponding alert condition is still fulfilled.

Control Register (B)

The operation of the LTC2944 is controlled by programming the control register. Table 3 shows the organization of the 8-bit control register B[7:0].

Table 3. Control Register B

BIT	NAME	OPERATION	DEFAULT																		
B[7:6]	ADC Mode	[11] Automatic Mode: continuously performing voltage, current and temperature conversions [10] Scan Mode: performing voltage, current and temperature conversion every 10s [01] Manual Mode: performing single conversions of voltage, current and temperature then sleep [00] Sleep	[00]																		
B[5:3]	Prescaler M	Sets coulomb counter prescaling factor M between 1 and 4096. Default is 4096. Maximum value is limited to 4096 <table><tr><td>B[5:3]</td><td>M</td></tr><tr><td>000</td><td>1</td></tr><tr><td>001</td><td>4</td></tr><tr><td>010</td><td>16</td></tr><tr><td>011</td><td>64</td></tr><tr><td>100</td><td>256</td></tr><tr><td>101</td><td>1024</td></tr><tr><td>110</td><td>4096</td></tr><tr><td>111</td><td>4096</td></tr></table>	B[5:3]	M	000	1	001	4	010	16	011	64	100	256	101	1024	110	4096	111	4096	[111]
B[5:3]	M																				
000	1																				
001	4																				
010	16																				
011	64																				
100	256																				
101	1024																				
110	4096																				
111	4096																				

BITS	NAME	OPERATION	DEFAULT
B[2:1]	ALCC Configure	Configures the ALCC pin. [10] Alert Mode. Alert functionality enabled. Pin becomes logic output. [01] Charge Complete Mode. Pin becomes logic input and accepts charge complete inverted signal (e.g., from a charger) to set accumulated charge register (C,D) to FFFFh. [00] ALCC pin disabled. [11] Not allowed.	[10]
B[0]	Shutdown	Shut down analog section to reduce I_{SUPPLY} .	[0]

Power Down B[0]

Setting B[0] to 1 shuts down the analog parts of the LTC2944, reducing the current consumption to less than 15µA (typical). The circuitry managing I²C communication remains operating and the values in the registers are retained. Note that any charge flowing while B[0] is 1 is not measured and any charge information below 1LSB of the accumulated charge register is lost.

Alert/Charge Complete Configuration B[2:1]

The ALCC pin is a dual function pin configured by the control register. By setting bits B[2:1] to [10] (default), the ALCC pin is configured as an alert pin following the SMBus protocol. In this configuration, the ALCC is pulled low if one of the four measured quantities (charge, voltage, current, temperature) exceeds its high or low threshold or if the value of the accumulated charge register overflows or underflows. An alert response procedure started by the master resets the alert at the ALCC pin. If the configuration of the ALCC pin is changed while it is pulled low due to an alert condition, the part will continue to pull ALCC low until a successful alert response procedure (ARA) has been issued by the master. For further information see the Alert Response Protocol section.

Setting the control bits B[2:1] to [01] configures the ALCC pin as a digital input. In this mode, a low input on the ALCC pin indicates to the LTC2944 that the battery is full and the accumulated charge register is set to its maximum, value FFFFh.

APPLICATIONS INFORMATION

If neither the alert nor the charge complete functionality is desired, bits B[2:1] should be set to [00]. The $\overline{\text{ALCC}}$ pin is then disabled and should be tied to the supply of the I²C bus with a 10k resistor.

Avoid setting B[2:1] to [11] as it enables the alert and the charge complete modes simultaneously.

Choosing R_{SENSE}

To achieve the specified precision of the coulomb counter, the differential voltage between SENSE⁺ and SENSE⁻ must stay within $\pm 50\text{mV}$. With input signals up to 300mV the LTC2944 will remain functional but the precision of the coulomb counter is not guaranteed.

The required value of the external sense resistor, R_{SENSE}, is determined by the maximum input range of V_{SENSE} and the maximum current of the application:

$$R_{\text{SENSE}} \leq \frac{50\text{mV}}{I_{\text{MAX}}}$$

The choice of the external sense resistor value influences the gain of the coulomb counter. A larger sense resistor gives a larger differential voltage between SENSE⁺ and SENSE⁻ for the same current resulting in more precise coulomb counting. The amount of charge represented by the least significant bit (q_{LSB}) of the accumulated charge (registers C, D) is equal to:

$$q_{\text{LSB}} = 0.340\text{mAh} \cdot \frac{50\text{m}\Omega}{R_{\text{SENSE}}} \cdot \frac{M}{4096}$$

or

$$q_{\text{LSB}} = 0.340\text{mAh} \cdot \frac{50\text{m}\Omega}{R_{\text{SENSE}}}$$

when the prescaler is set to its default value of M = 4096.

Note that 1mAh = 3.6C (coulomb).

Choosing R_{SENSE} = 50mV/I_{MAX} is not sufficient in applications where the battery capacity (Q_{BAT}) is very large compared to the maximum current (I_{MAX}):

$$Q_{\text{BAT}} > I_{\text{MAX}} \cdot 22\text{Hours}$$

For such low current applications with a large battery, choosing R_{SENSE} according to R_{SENSE} = 50mV/I_{MAX} can lead to a q_{LSB} smaller than Q_{BAT}/2¹⁶ and the 16-bit accumulated charge register may underflow before the battery is exhausted or overflow during charge. Choose, in this case, a maximum R_{SENSE} of:

$$R_{\text{SENSE}} \leq \frac{0.340\text{mAh} \cdot 2^{16}}{Q_{\text{BAT}}} \cdot 50\text{m}\Omega$$

In an example application where the maximum current is I_{MAX} = 100mA, calculating R_{SENSE} = 50mV/I_{MAX} would lead to a sense resistor of 500mΩ. This gives a q_{LSB} of 34μAh and the accumulated charge register can represent a maximum battery capacity of Q_{BAT} = 34μAh • 65535 = 2228mAh. If the battery capacity is larger, R_{SENSE} must be lowered. For example, R_{SENSE} should be reduced to 150mΩ if a battery with a capacity of 7200mAh is used.

Choosing Coulomb Prescaler M B[5:3]

If the battery capacity (Q_{BAT}) is small compared to the maximum current (I_{MAX}) the prescaler value M should be changed from its default value (4096).

In these applications with a small battery but a high maximum current, q_{LSB} can get quite large with respect to the battery capacity. For example, if the battery capacity is 100mAh and the maximum current is 1A, the standard equation leads to choosing a sense resistor value of 50mΩ, resulting in:

$$q_{\text{LSB}} = 0.340\text{mAh} = 1224\text{mC}$$

The battery capacity then corresponds to only 294 q_{LSB} and less than 0.5% of the accumulated charge register is utilized.

To preserve digital resolution in this case, the LTC2944 includes a programmable prescaler. Lowering the prescaler factor M reduces q_{LSB} to better match the accumulated charge register to the capacity of the battery. The prescaling factor M can be chosen between 1 and its default value of 4096. The charge LSB then becomes:

$$q_{\text{LSB}} = 0.34\text{mAh} \cdot \frac{50\text{m}\Omega}{R_{\text{SENSE}}} \cdot \frac{M}{4096}$$

APPLICATIONS INFORMATION

To use as much of the range of the accumulated charge register as possible the prescaler factor M should be chosen for a given battery capacity Q_{BAT} and a sense resistor R_{SENSE} as:

$$M \geq 4096 \cdot \frac{Q_{BAT}}{2^{16} \cdot 0.340\text{mAh}} \cdot \frac{R_{SENSE}}{50\text{m}\Omega}$$

M can be set to 1, 4, 16, ... 4096 by programming B[5:3] of the control register as $M = 2^2 \cdot (4 \cdot B[5] + 2 \cdot B[4] + B[3])$. The default value is 4096.

In the above example of a 100mAh battery and an R_{SENSE} of 50m Ω , the prescaler should be programmed to $M = 64$. The q_{LSB} is then 5.313 μ Ah and the battery capacity corresponds to roughly 18821 q_{LSBs} .

Figure 3 illustrates the best choice for prescaler value M and the sense resistor as function of the ratio between battery capacity (Q_{BAT}) and maximum current (I_{MAX}). It can be seen, that for high current applications with low battery capacity the prescaler value should be reduced, whereas in low current applications with a large battery the sense resistor should be reduced with respect to its default value of 50mV/ I_{MAX} .

ADC Mode B[7:6]

The LTC2944 features an ADC which measures either voltage on SENSE⁻ (battery voltage), voltage difference between SENSE⁺ and SENSE⁻ (battery current) or temperature via an internal temperature sensor. The reference voltage and clock for the ADC are generated internally.

The ADC has four different modes of operation as shown in Table 3. These modes are controlled by bits B[7:6] of

the control register. At power-up, bits B[7:6] are set to [00] and the ADC is in sleep mode.

A single conversion of the three measured quantities is initiated by setting the bit B[7:6] to [01]. After three conversions (voltage, current and temperature), the ADC resets B[7:6] to [00] and goes back to sleep.

The LTC2944 is set to scan mode by setting B[7:6] to [10]. In scan mode the ADC converts voltage, current, then temperature, then sleeps for approximately ten seconds. It then reawakens automatically and repeats the three conversions. The chip remains in scan mode until reprogrammed by the host.

Programming B[7:6] to [11] sets the chip into automatic mode where the ADC continuously performs voltage, current and temperature conversions. The chip stays in automatic mode until reprogrammed by the host.

Programming B[7:6] to [00] puts the ADC to sleep. If control bits B[7:6] change within a conversion, the ADC will complete the running cycle of conversions before entering the newly selected mode.

A conversion of voltage requires 33ms (typical), and current and temperature conversions are completed in 4.5ms (typical). At the end of each conversion, the corresponding registers are updated. If the converted quantity exceeds the values programmed in the threshold registers, a flag is set in the status register and the $\overline{ALCC}$ pin is pulled low (if alert mode is enabled).

During ADC conversions additional currents are sunk from SENSE⁺ and SENSE⁻, refer to the Electrical Characteristics table for details.

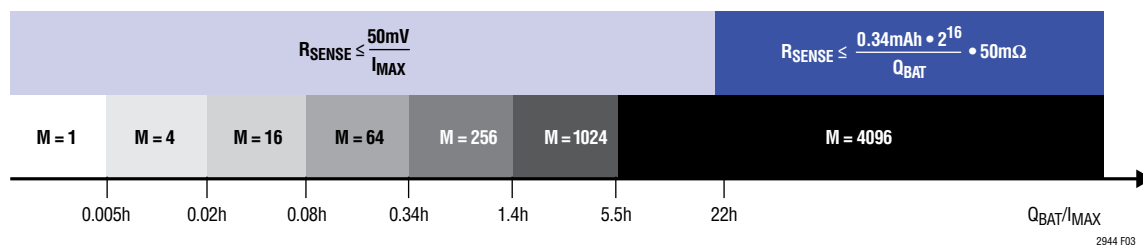


Figure 3. Choice of Sense Resistor and Prescaler as Function of Battery Capacity and Maximum Current

2944 F03

APPLICATIONS INFORMATION

Alert Threshold Registers (E,F,G,H,K,L,M,N,Q,R,S,T,W,X)

For each of the measured quantities (battery charge, voltage, current and temperature) the LTC2944 features high and low threshold registers. At power-up, the high thresholds are set to FFFFh while the low thresholds are set to 0000h, with the effect of disabling them. All thresholds can be programmed to a desired value via I²C. As soon as a measured quantity exceeds the high threshold or falls below the low threshold, the LTC2944 sets the corresponding flag in the status register and pulls the $\overline{\text{ALCC}}$ pin low if alert mode is enabled via bits B[2:1].

Accumulated Charge Register (C,D)

The coulomb counting circuitry in the LTC2944 integrates current through the sense resistor. The result of this charge integration is stored in the 16-bit accumulated charge register (registers C, D). As the LTC2944 does not know the actual battery status at power-up, the accumulated charge register (ACR) is set to mid-scale (7FFFh). If the host knows the status of the battery, the accumulated charge (C[7:0]D[7:0]) can be either programmed to the correct value via I²C or it can be set after charging to FFFFh (full) by pulling the $\overline{\text{ALCC}}$ pin low if charge complete mode is enabled via bits B[2:1]. Note that before writing to the accumulated charge registers, the analog section should be temporarily shut down by setting B[0] to 1. In order to avoid a change in the accumulated charge registers between reading MSBs C[7:0] and LSBs D[7:0], it is recommended to read them sequentially as shown in Figure 11.

Voltage Registers (I,J), and Voltage Threshold Registers (K,L,M,N)

The result of the 16-bit ADC conversion of the voltage at SENSE⁻ is stored in the voltage registers (I, J).

From the result of the 16-bit voltage registers I[7:0]J[7:0] the measured voltage can be calculated as:

$$V_{\text{SENSE}^-} = 70.8\text{V} \cdot \frac{\text{RESULT}_h}{\text{FFFF}_h} = 70.8\text{V} \cdot \frac{\text{RESULT}_{\text{DEC}}}{65535}$$

Example 1: a register value I[7:0] = B0h and J[7:0] = 1Ch corresponds to a voltage on SENSE⁻ of:

$$V_{\text{SENSE}^-} = 70.8\text{V} \cdot \frac{\text{B01Ch}_h}{\text{FFFF}_h} = 70.8\text{V} \cdot \frac{45084_{\text{DEC}}}{65535} \approx 48.705\text{V}$$

Example 2: To set a low level threshold for the battery voltage of 31.2V, register M should be programmed to 70h and register N to D0h.

Current Registers (O,P), and Current Threshold Registers (Q,R,S,T)

The result of the current conversion is stored in the current registers (O,P).

As the ADC resolution is 12 bits in current mode, the lowest four bits of the combined current registers (O, P) are always zero.

The ADC measures battery current by converting the voltage, V_{SENSE} , across the sense resistor R_{SENSE} . Depending whether the battery is being charged or discharged the measured voltage drop on R_{SENSE} is positive or negative. The result is stored in registers O and P in excess-32767 representation. O[7:0] = FFh, P[7:0] = F0h corresponds to the full scale positive voltage 64mV. While O[7:0] = 00h, P[7:0] = 00h corresponds to the full scale negative voltage -64mV. The battery current can be obtained from the two byte register O[7:0]P[7:0] and the value of the chosen sense resistor R_{SENSE} :

$$I_{\text{BAT}} = \frac{V_{\text{SENSE}}}{R_{\text{SENSE}}} = \frac{64\text{mV}}{R_{\text{SENSE}}} \cdot \left(\frac{\text{RESULT}_h - 7\text{FFF}_h}{7\text{FFF}_h} \right) = \frac{64\text{mV}}{R_{\text{SENSE}}} \cdot \left(\frac{\text{RESULT}_{\text{DEC}} - 32767}{32767} \right)$$

Positive current is measured when the battery is charging and negative current is measured when the battery is discharging.

APPLICATIONS INFORMATION

Example 1: a register value of O[7:0] = A8h P[7:0] = 40h together with a sense resistor $R_{\text{SENSE}} = 50\text{m}\Omega$ corresponds to a battery current:

$$I_{\text{BAT}} = \frac{64\text{mV}}{50\text{m}\Omega} \cdot \left(\frac{A840_h - 7FFF_h}{7FFF_h} \right) = \frac{64\text{mV}}{50\text{m}\Omega} \cdot \left(\frac{43072 - 32767}{32767} \right) \approx 402.5\text{mA}$$

The positive current result indicates that the battery is being charged.

The values in the threshold register for the current mode Q,R,S,T are also expressed in excess -32767 representation in the same manner as the current conversion result. The alert after a current measurement is set if the result is higher than the value stored in the high threshold registers Q,R or lower than the value stored in the low value registers S,T.

Example 2: In an application, the user wants to get an alert if the absolute current through the sense resistor, R_{SENSE} , of $50\text{m}\Omega$ exceeds 1A. This is achieved by setting the upper threshold I_{HIGH} in register [Q,R] to 1A and the lower threshold I_{LOW} in register [S,T] to -1A. The formula for I_{BAT} leads to:

$$I_{\text{HIGH(DEC)}} = \left(\frac{1\text{A} \cdot 50\text{m}\Omega}{64\text{mV}} \cdot 32767 \right) + 32767 = 58366$$

$$I_{\text{LOW(DEC)}} = \left(\frac{-1\text{A} \cdot 50\text{m}\Omega}{64\text{mV}} \cdot 32767 \right) + 32767 = 7168$$

Leading the user to set Q[7:0] = E3h, R[7:0] = FEh for the high threshold and S[7:0] = 1Bh and T[7:0] = FFh for the low threshold.

Temperature Registers (U,V) and Temperature Threshold Registers (W,X)

As the ADC resolution is 11 bits in temperature mode, the lowest five bits of the combined temperature registers (U, V) are always zero.

The actual temperature can be obtained from the two byte register U[7:0]V[7:0] by:

$$T = 510\text{K} \cdot \frac{\text{RESULT}_h}{FFFF_h} = 510\text{K} \cdot \frac{\text{RESULT}_{\text{DEC}}}{65535}$$

Example: a register value of U[7:0] = 96h V[7:0] = 96h corresponds to $\sim 300\text{K}$ or $\sim 27^\circ\text{C}$

A high temperature limit of 60°C is programmed by setting register W to A7h. Note that the temperature threshold register is single byte register and only the eight MSBs of the 11 bits temperature result are checked.

Effect of Differential Offset Voltage on Total Charge Error

In battery gas gauges, an important parameter is the differential offset (V_{OS}) of the circuitry monitoring the battery charge. Many coulomb counter devices perform an analog to digital conversion of V_{SENSE} , where V_{SENSE} is the voltage drop across the sense resistor, and accumulate the conversion results to infer charge. In such an architecture, the differential offset V_{OS} causes relative charge error of $V_{\text{OS}}/V_{\text{SENSE}}$. For small V_{SENSE} values V_{OS} can be the main source of error.

The LTC2944 performs the tracking of the charge with an analog integrator. This approach allows to continuously monitor the battery charge and significantly lowers the error due to differential offset. The relative charge error due to offset (CE_{OV}) can be expressed by:

$$\text{CE}_{\text{OV}} = \left(\frac{V_{\text{OS}}}{V_{\text{SENSE}}} \right)^2$$

As example, at a 1mV input signal a differential voltage offset $V_{\text{OS}} = 20\mu\text{V}$ results in a 2% error using digital integration, whereas the error is only 0.04% (a factor of 50 times smaller!) using the analog integration approach of LTC2944.

The reduction of the impact of the offset in LTC2944 can be explained by its integration scheme depicted in Figure 2. While positive offset accelerates the up ramping of the integrator output from REFLO to REFHI, it slows the down ramping from REFHI to REFLO thus the effect is largely canceled as depicted in Figure 4.

APPLICATIONS INFORMATION

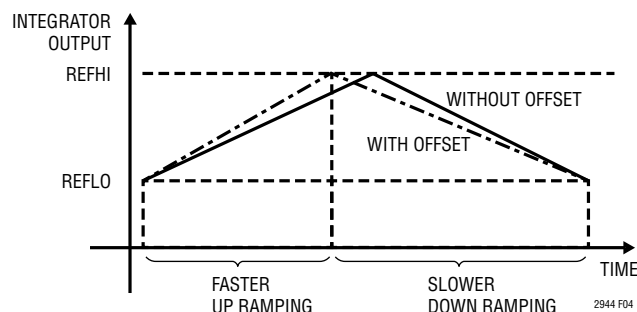


Figure 4. Offset Cancellation

For input signals with an absolute value smaller than the offset of the internal op amp the LTC2944 stops integrating and does not integrate its own offset.

I²C/SMBus Interface

The LTC2944 communicates with a bus master using a 2-wire interface compatible with I²C and SMBus. The 7-bit hard coded I²C address of the LTC2944 is 1100100.

The LTC2944 is a slave only device. The serial clock line (SCL) is input only while the serial data line (SDA) is bidirectional. The device supports I²C standard and fast mode. For more details refer to the I²C Protocol section.

I²C Protocol

The LTC2944 uses an I²C/SMBus-compatible 2-wire interface supporting multiple devices on a single bus. Connected devices can only pull the bus lines low and must never drive the bus high. The bus wires are externally connected to a positive supply voltage via current sources or pull-up resistors. When the bus is idle, all bus lines are high. Data on the I²C bus can be transferred at rates of up to 100kbit/s in standard mode and up to 400kbit/s in fast mode.

Each device on the I²C/SMBus is recognized by a unique address stored in that device and can operate as either a transmitter or receiver, depending on the function of the device. In addition to transmitters and receivers, devices can also be classified as masters or slaves when performing data transfers. A master is the device which initiates a data transfer on the bus and generates the clock signals to permit that transfer. At the same time any device addressed is considered a slave. The LTC2944 always acts as a slave.

Figure 5 shows an overview of the data transmission on the I²C bus.

Start and Stop Conditions

When the bus is idle, both SCL and SDA must be high. A bus master signals the beginning of a transmission with a START condition by transitioning SDA from high to low while SCL is high. When the master has finished communicating with the slave, it issues a STOP condition by transitioning SDA from low to high while SCL is high. The bus is then free for another transmission. When the bus is in use, it stays busy if a repeated START (Sr) is generated instead of a STOP condition. The repeated START (Sr) conditions are functionally identical to the START (S).

Write Protocol

The master begins a write operation with a START condition followed by the seven bit slave address 1100100 and the R/W bit set to zero, as shown in Figure 6. The LTC2944 acknowledges this by pulling SDA low and the master sends a command byte which indicates which internal register the master is to write. The LTC2944 acknowledges and latches the command byte into its internal register address pointer. The master delivers the data byte, the LTC2944 acknowledges once more and latches the data

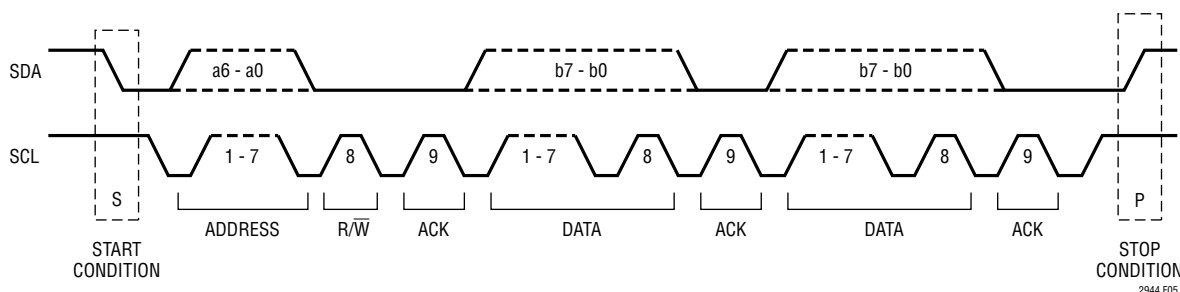


Figure 5. Data Transfer Over I²C or SMBus

APPLICATIONS INFORMATION

into the desired register. The transmission is ended when the master sends a STOP condition. If the master continues by sending a second data byte instead of a stop, the LTC2944 acknowledges again, increments its address pointer and latches the second data byte in the following register, as shown in Figure 7.

S	ADDRESS	W	A	REGISTER	A	DATA	A	P
	1100100	0	0	01h	0	FCh	0	

2944 F06

☐ FROM MASTER TO SLAVE A: ACKNOWLEDGE (LOW)
☐ FROM SLAVE TO MASTER Ā: NOT ACKNOWLEDGE (HIGH)

S: START CONDITION
 P: STOP CONDITION
 R: READ BIT (HIGH)
 W: WRITE BIT (LOW)

Figure 6. Writing FCh to the LTC2944 Control Register (B)

S	ADDRESS	W	A	REGISTER	A	DATA	A	DATA	A	P
	1100100	0	0	02h	0	F0h	0	01h	0	

2944 F07

Figure 7. Writing F001h to the LTC2944 Accumulated Charge Register (C, D)

Read Protocol

The master begins a read operation with a START condition followed by the seven bit slave address 1100100 and the R/W bit set to zero, as shown in Figure 8. The LTC2944 acknowledges and the master sends a command byte which indicates which internal register the master is to read. The LTC2944 acknowledges and then latches the

command byte into its internal register address pointer. The master then sends a repeated START condition followed by the same seven bit address with the R/W bit now set to one. The LTC2944 acknowledges and sends the contents of the requested register. The transmission is ended when the master sends a STOP condition. If the master acknowledges the transmitted data byte, the LTC2944 increments its address pointer and sends the contents of the following register as depicted in Figure 9.

Alert Response Protocol

In a system where several slaves share a common interrupt line, the master can use the alert response address (ARA) to determine which device initiated the interrupt (Figure 10).

The master initiates the ARA procedure with a START condition and the special 7-bit ARA bus address (0001100) followed by the read bit (R) = 1. If the LTC2944 is asserting the ALCC pin in alert mode, it acknowledges and responds by sending its 7-bit bus address (1100100) and a 0. While it is sending its address, it monitors the SDA pin to see if another device is sending an address at the same time using standard I²C bus arbitration. If the LTC2944 is sending a 1 and reads a 0 on the SDA pin on the rising edge of SCL, it assumes another device with a lower address is sending and the LTC2944 immediately aborts its transfer and waits for the next ARA cycle to try again. If transfer is successfully completed, the LTC2944 will stop pulling down the ALCC pin and will not respond to further ARA requests until a new Alert event occurs.

S	ADDRESS	W	A	REGISTER	A	Sr	ADDRESS	R	A	DATA	Ā	P
	1100100	0	0	00h	0		1100100	1	0	01h	1	

2944 F08

Figure 8. Reading the LTC2944 Status Register (A)

S	ADDRESS	W	A	REGISTER	A	Sr	ADDRESS	R	A	DATA	A	DATA	Ā	P
	1100100	0	0	08h	0		1100100	1	0	F1h	0	24h	1	

2944 F09

Figure 9. Reading the LTC2944 Voltage Register (I, J)

APPLICATIONS INFORMATION

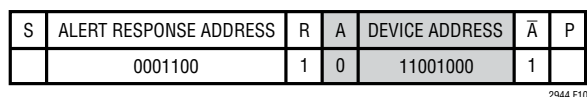


Figure 10. LTC2944 Serial Bus SDA Alert Response Protocol

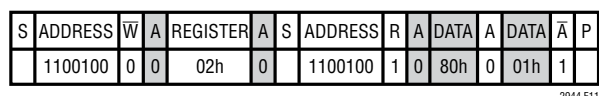


Figure 11. Reading the LTC2944 Accumulated Charge Registers (C, D)

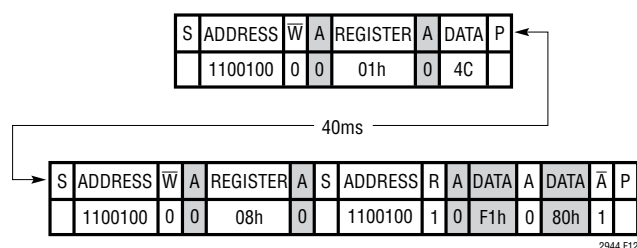


Figure 12. ADC Single Conversion Sequence and Reading of Voltage Registers (I, J)

PC Board Layout Suggestions

Keep all traces as short as possible to minimize noise and inaccuracy. Use a 4-wire Kelvin sense connection for the sense resistor, locating the LTC2944 close to the resistor with short sense-traces to the SENSE⁺ and SENSE⁻ pins. Use wider traces from the resistor to the battery, load and/or charger. Put the bypass capacitor close to SENSE⁺ and GND.

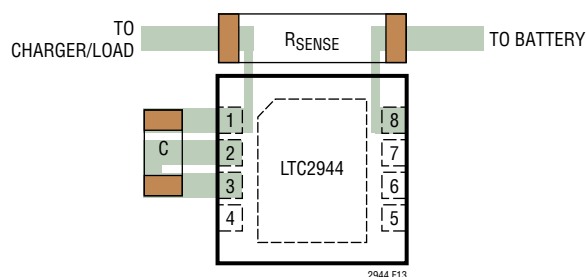


Figure 13. Kelvin Connection on Sense Resistor

Preventing Violation of Absolute Maximum Ratings

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the supply bypass capacitor of LTC2944. However, these capacitors can cause problems if the LTC2944 is plugged into a live supply close to its maximum voltage of 65V. The low loss ceramic capacitor, combined with stray inductance in series with the power source, forms an under damped tank circuit, and the voltage at the SENSE⁻ pin of the LTC2944 can ring several tens of volts, possibly exceeding the LTC2944 rating and damaging the part. This can be prevented by adding a transient voltage suppression diode to the SENSE⁻ pin as shown in Figure 14.

Also pulling the digital communication pins SCL, SDA and ALCC below their minimum absolute maximum voltage of -0.3V—for example, due to differences between the local GND and the GND of the connected microprocessor—increases the supply current of the LTC2944. At supply voltages above 50V, the power dissipated due to the increased supply current might damage the part, which can be prevented by adding Schottky diodes as shown in Figure 14.

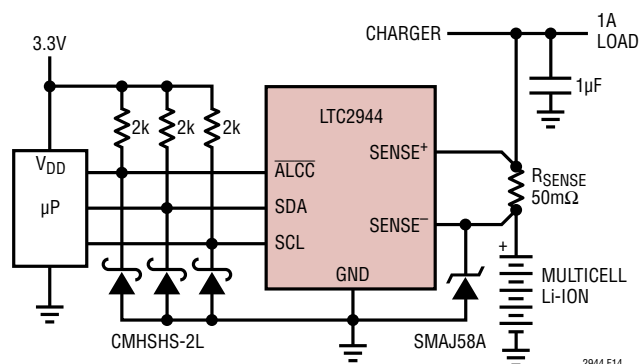
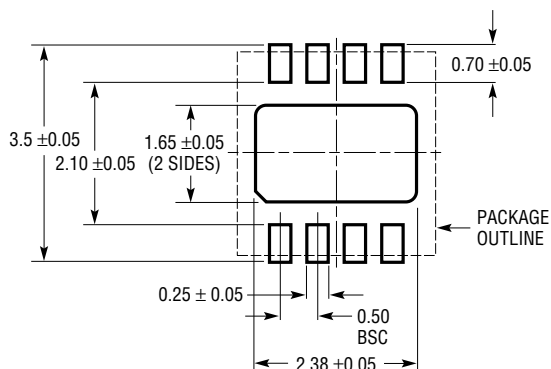


Figure 14. Preventing Violation of Absolute Maximum Ratings

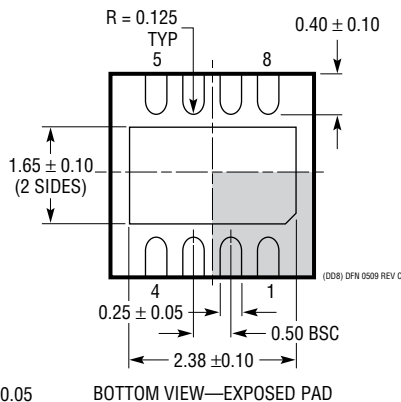
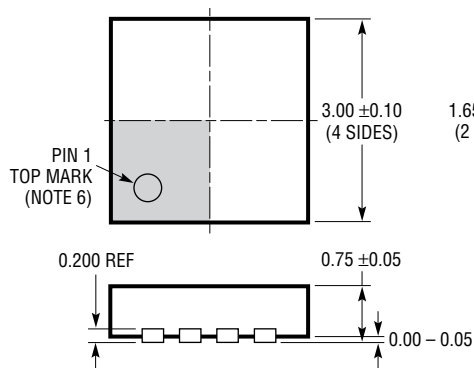
PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/product/LTC2944#packaging> for the most recent package drawings.

DD Package
8-Lead Plastic DFN (3mm × 3mm)
 (Reference LTC DWG # 05-08-1698 Rev C)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



NOTE:

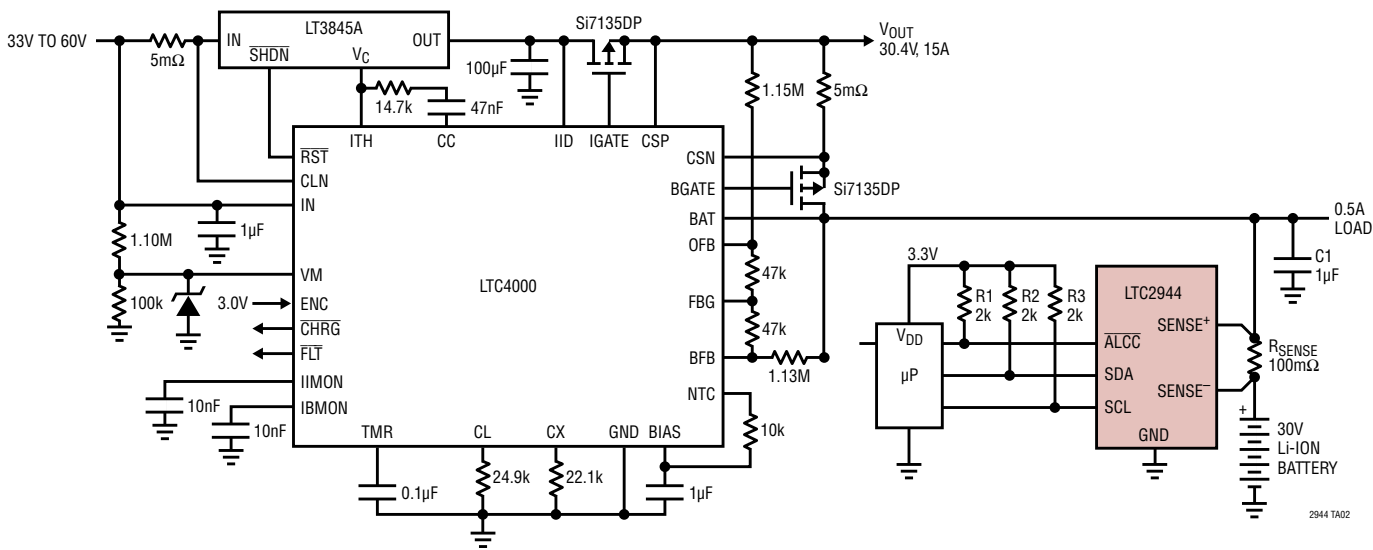
1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE MO-229 VARIATION OF (WEED-1)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON TOP AND BOTTOM OF PACKAGE

REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	10/17	Updated equation for obtaining temperature (T)	15

TYPICAL APPLICATION

Battery Charger with Gas Gauge



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
Battery Gas Gauges		
LTC2943	I ² C Battery Gas Gauge with Voltage, Current and Temperature ADC	3.6V to 20V Operation, 14-Bit ΔΣ-ADC, Pin Compatible with LTC2944, LTC2943-1, 8-Lead (3mm × 3mm) DFN Package
LTC2943-1	1A Multicell Battery Gas Gauge with Temperature, Voltage and Current Measurement	3.6V to 20V Operation, Internal Sense Resistor, 14-Bit ΔΣ ADC, Pin Compatible with LTC2944 and LTC2943, 8-Lead (3mm × 3mm) DFN Package
LTC2941	I ² C Battery Gas Gauge	2.7V to 5.5V Operation, 6-Lead (2mm × 3mm) DFN Package
LTC2941-1	1A I ² C Battery Gas Gauge with Internal Sense Resistor	2.7V to 5.5V Operation, 6-Lead (2mm × 3mm) DFN Package
LTC2942	I ² C Battery Gas Gauge with Temperature, Voltage Measurement	2.7V to 5.5V Operation, 14-Bit ΔΣ-ADC, 6-Lead (2mm × 3mm) DFN Package
LTC2942-1	1A I ² C Battery Gas Gauge with Internal Sense Resistor and Temperature/Voltage Measurement	2.7V to 5.5V Operation, 14-Bit ΔΣ-ADC, 6-Lead (2mm × 3mm) DFN Package
LTC4150	Coulomb Counter/Battery Gas Gauge	2.7V to 8.5V Operation, 10-Pin MSOP Package
Battery Chargers		
LTC4000	High Voltage High Current Controller for Battery Charging and Power Management	3V to 60V Operation, 28-Lead (4mm × 5mm) QFN or SSOP Packages
LTC4009	High Efficiency, Multi-Chemistry Battery Charger	6V to 28V Operation, 20-Lead (4mm × 4mm) QFN Package
LTC4012	High Efficiency, Multi-Chemistry Battery Charger with PowerPath™ Control	6V to 28V Operation, 20-Lead (4mm × 4mm) QFN Package
LT®3652HV	Power Tracking 2A Battery Charger	Input Supply Voltage Regulation Loop for Peak Power Tracking, 5V to 34V Operation, 1MHz, 2A Charge Current, 3mm × 3mm DFN-12 and MSOP-12 Packages

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9